

Preparation and characterization of all-oxide $\text{CuFeO}_2\text{:Zn/ZnO:Al}$ transparent heterojunction diode by using all-chemical solution deposition

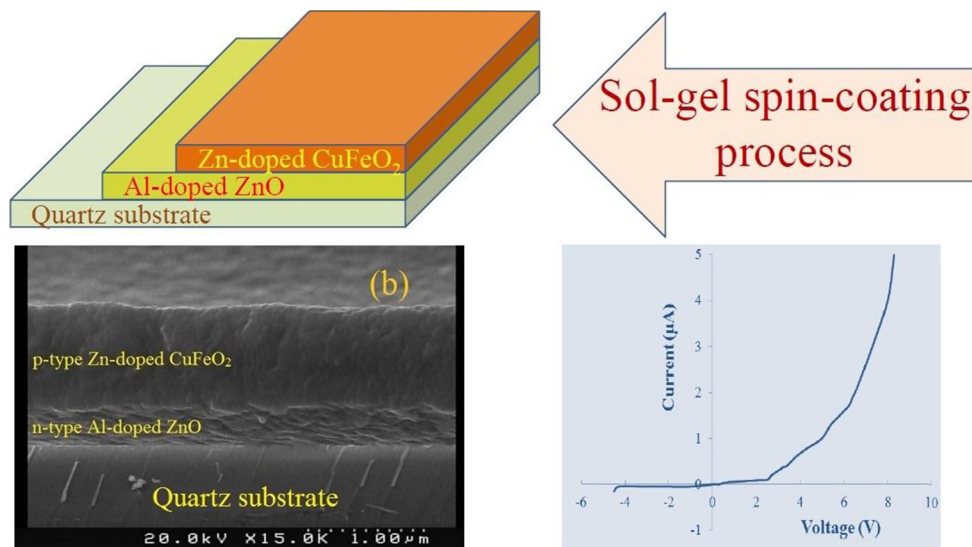
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Abstract Transparent p-n heterojunction thin-film diodes have been fabricated through an all-chemical solution deposition as a low-cost and large-scale method. In this order, we firstly studied the structural, optical and electrical properties of fabricated n-ZnO:Al and p-CuFeO₂:Zn layers. The deposited ZnO:Al thin film showed a transmission more than 90 % in the visible range, and its smooth surface provided a suitable substrate for preparation of the diode. The

current–voltage characteristic of the $\text{CuFeO}_2\text{:Zn/ZnO:Al}$ p-n junction demonstrated rectifying property. The diode with a total thickness of 1240 nm exhibited around 60 % optical transparency in the visible region which makes it suitable for invisible electronic and optoelectronic devices.

Graphical Abstract



Keywords All-chemical solution deposition · Transparent diode · p-n junction

1 Introduction

Transparent conducting oxides (TCOs) are used in optoelectronics due to their wide band gap and also high conductivity [1]. Transparent optoelectronic devices such as

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functional windows, transparent or semitransparent solar cells and light-emitting diodes require both n-type and p-type transparent materials [2]. n-type TCOs such as Sn-doped In_2O_3 (ITO), Al-doped ZnO (AZO) and F-doped SnO_2 (FTO) are well known and have been studied for many years [3]. However, p-type TCOs such as CuAlO_2 , CuCrO_2 and CuGaO_2 have only recently been investigated [4]. The conductivity of transparent p-type conductors is usually lower than that of n-type TCOs because of lower mobility of holes in p-type TCOs compared to that of electrons in n-type ones.

Al-doped zinc oxide is one of the n-type oxide semiconductors with direct wide band gap (3.37 eV at room temperature) which is used in fabrication of optoelectronic devices in the blue and ultraviolet regions. AZO has high electrical conductivity and show high optical transparency in the visible region [5, 6]. It has attracted interest as a transparent electrode for thin-film solar cells, light-emitting diodes and gas sensors. Similarly, AMO_2 ($A = \text{Pd}, \text{Cu}$ and $M = \text{Al}, \text{In}, \text{Fe}, \text{Cr}$) is a noble metal oxide alike n-type TCOs with the difference that the AMO_2 TCO has p-type conductivity [7, 8]. For the first time, Kawazoe et al. reported the synthesis of p-type delafossite CuAlO_2 thin films by pulsed laser deposition that possess both high electrical conductivity and transparency in visible region [9]. CuFeO_2 is another delafossite-type TCO with p-type conductivity and good electro-optical properties. The crystal structure of CuFeO_2 belongs to the space group $R\bar{3}m$ with $a_h = 3.03 \text{ \AA}$ and $c_h = 17.09 \text{ \AA}$ in the hexagonal description [10, 11]. This TCO has been intensively studied due to its various electrical, optical and magnetic applications. For instance, antiferromagnetic structure and field-induced magnetic-phase transitions of CuFeO_2 were recognized by Terada et al. [12]. CuFeO_2 thin films were fabricated on glass substrate by RF magnetron sputtering, and p-type conductivity of CuFeO_2 was studied using thermopower measurements [13]. The pulsed laser deposition method was also used to fabricate CuFeO_2 thin films on amorphous glass substrates by Choi et al. [10]. In addition, Chen and Wu constructed transparent and conductive CuFeO_2 thin films by using sol-gel method [11].

As mentioned above, one application of p- and n-type TCOs is in fabricating transparent thin-film diodes. The first work on transparent heterojunction was reported by Sato et al. [14] on semitransparent p-NiO/i-NiO/i-ZnO/n-ZnO heterojunction with 20 % visible transparency. Afterward, various groups reported the fabrication of p-i-n and p-n homojunction and heterojunction diodes with proper electro-optical properties for potential application in invisible electronics. Most of fabricated diode structures are heterojunctions such as p-SrCu₂O₂/n-ZnO [15], p-SrCu₂O₂/i-ZnO/n-ZnO [16], p-CuY_{1-x}Ca_xO₂/n-Zn_{1-x}Al_xO [17], p-CuY_{1-x}Ca_xO₂/i-ZnO/n-ITO [18], $\text{CuCrO}_2\text{:Mg/ZnO}$ [1, 19].

As fabricated homojunction diodes, we can also point to p-CuIn_{1-x}Ca_xO₂/n-CuIn_{1-x}SnO₂ [20], p-ZnO:P/n-ZnO [21] and p-ZnO:As/n-ZnO [22]. In order to fabricate thin-film diodes, each layer is deposited on the substrate by one of the thin-film deposition methods such as pulsed laser deposition, RF magnetron sputtering, reactive evaporation and thermal evaporation [8, 23–25] and chemical solution deposition [11, 26, 27]. The physical methods of preparing transparent diodes are complex, expensive and, moreover, need high vacuum. On the contrary, the chemical solution methods of preparing multilayers have cost-reduction advantage [11].

In this paper, we report the all-chemical solution fabrication of a TCO diode based on p-CuFeO₂:Zn. The n-type semiconductor utilized to construct the transparent heterojunction is Al-doped ZnO. Prior to create this TCO diode, we fabricate and characterize n-type ZnO:Al and p-type CuFeO₂:Zn thin layers. The diode I–V characteristic of CuFe_{0.95}Zn_{0.05}O₂/Zn_{0.99}Al_{0.01}O heterojunction verifies the ability of chemical solution deposition method to create diode structure.

2 Experimental details

To prepare Zn_{1-x}Al_xO thin film, Zn(CH₃COO)₂·2H₂O and Al(NO₃)₃·9H₂O were used as starting materials. Furthermore, 2-methoxyethanol and monoethanolamine were used as solvent and stabilizer, respectively. The concentration of Zn metallic ion was 0.7 molar, and the molar ratio between ethanolamine and metallic ions (Zn + Al) was kept at 1. Firstly, starting materials were dissolved in the solvent. Then, monoethanolamine was added to the solution as a stabilizer. The mixed solution was stirred in a magnetic stirrer at 60 °C for 2 h to obtain a clear and transparent yellow solution. The resultant solution was aged for 48 h at room temperature.

For film preparation, the quartz substrate was firstly cleaned by acetone and ethanol in an ultrasonic bath before film deposition. The ZnO:Al solution was dropped onto quartz substrate, which was rotated at 3000 rpm for 30 s by using a Backer Viera Trading SC-410 spincoater. After deposition, the thin films were dried at 500 °C for 15 min in an air furnace to evaporate the solvent and organic residuals [28]. This process was repeated for six times to reach a desired thickness. Then, the obtained ZnO:Al thin films were annealed in a vacuum furnace (with a pressure of 10⁻⁵ mbar) at 500 °C for 1 h [29].

For fabrication of CuFeO₂:Zn thin films, we used Cu(CH₃OOH)₂·H₂O, Fe(NO₃)₃·9H₂O and Zn(CH₃COO)₂·2H₂O as starting materials. Similarly, 2-methoxyethanol and monoethanolamine were used as solvent and stabilizer, respectively. The concentration of the solution was 0.2 molar in respect of Cu metallic ions. Furthermore, the molar ratio between Cu and Fe + Zn was kept at 1. The

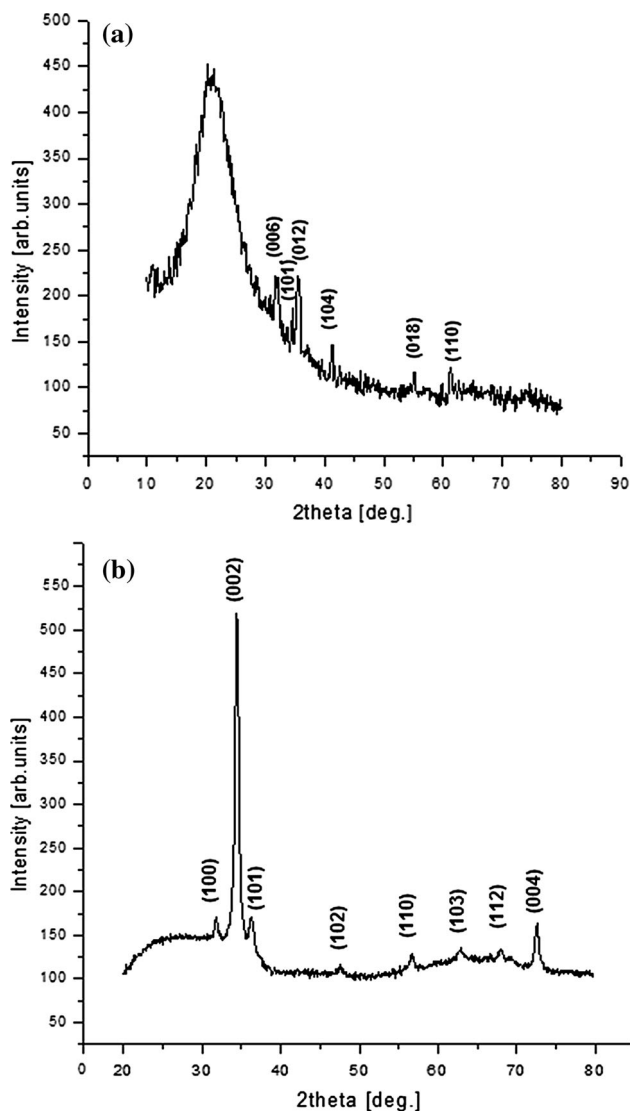


Fig. 1 XRD patterns of **a** $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ single layer annealed at $800\text{ }^\circ\text{C}$ in flowing argon gas (purity 99.99 %) atmosphere for 1 h and **b** $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ single layer annealed in a vacuum furnace (with a pressure of 10^{-5} mbar) at $500\text{ }^\circ\text{C}$ for 1 h

resulting solution was stirred at $60\text{ }^\circ\text{C}$ for 6 h to obtain a homogenous and transparent solution. Then, the precursor sol was dropped onto ZnO:Al/quartz film which was rotated at 2500 rpm for 30 s and then the resultant film was dried in the air furnace at $400\text{ }^\circ\text{C}$ for 20 min. This process was repeated for six times to increase the film thickness. Finally, the bilayers were annealed at $800\text{ }^\circ\text{C}$ in flowing argon gas (purity 99.99 %) atmosphere for 1 h [11].

The morphology and structural properties of the single layers and the bilayers were analyzed by X-ray diffraction (XRD), field emission scanning electron microscopy (FESEM) and atomic force microscopy (AFM). In addition, energy-dispersive X-ray spectroscopy (EDX) was used for analyzing Al and Zn distribution in AZO and

CuFeO_2 thin films, respectively. Moreover, optical properties were studied by UV–Vis–NIR spectrometry and we used the Hall effect measurement, four-probe point and two-probe point techniques to investigate the electrical properties of the layers. The contacts for electrical measurements were provided by using alligator clips.

3 Results and discussion

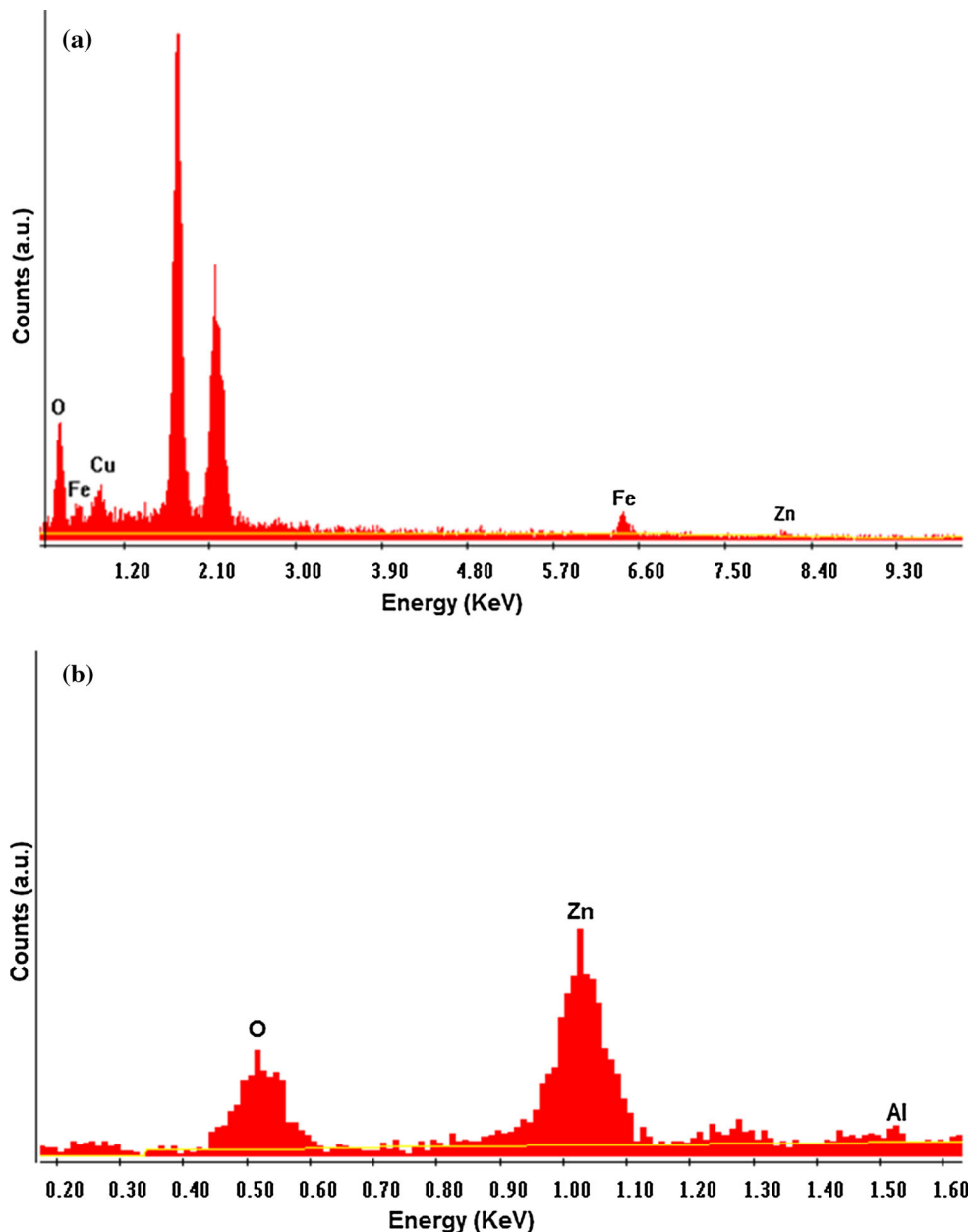
A heterojunction with diodic character should comprise proper n- and p-type semiconducting layers. Therefore, we firstly studied the structural, electrical and optical properties of n- and p-type layers. Then, the p-n heterojunction diode was fabricated and its properties were investigated. Regarding the scientific reports and our experience, we focused on the layers with nominal composition of $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ and $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ to construct the diode [30]. For simplicity, hereafter we label $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ n-type layer as AZO and $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ p-type layer as CFZO.

The XRD spectra of the prepared AZO and CFZO single layers deposited on quartz substrates are shown in Fig. 1. These patterns indicate that the AZO thin film possesses a polycrystalline ZnO with the hexagonal wurtzite structure and no signature of any impurity (JCPDS# 001-1136). Similarly, the diffraction peaks of CuFeO_2 are observed for the CFZO single layer without any extra phase (JCPDS# 74-1953). The XRD pattern of the CFZO illustrates that it is a polycrystalline thin film with a rhombohedral crystalline structure. Though no preferential crystalline direction is observed for the CFZO thin film, the AZO layer shows such a direction. The average crystallite size for (002) preferential orientation is determined by the Debye–Scherrer equation as 19 nm [31]. Similar results and crystallite size have been reported for Al-doped ZnO thin films by Ding et al. and Lin et al. [30, 32].

The energy-dispersive X-ray (EDX) spectra of CFZO and AZO single layers are shown in Fig. 2. According to this figure, the chemical composition ratio of CFZO thin film is Cu: 26.59, Fe: 17.48, O: 51.11 and Zn: 4.82. This set approximately corresponds to the molar ratio of Cu/Fe + Zn/ O (1:1:2). Similarly, the chemical composition of AZO thin film is Zn: 58.95, O: 39.72 and Al: 1.33. The slightly oxygen stoichiometry deviation in AZO thin film is due to the heat treatment in Ar atmosphere. It is well known that the heat treatment in vacuum or under an inert-gas ambient atmosphere causes the formation of oxygen vacancies and Zn interstitials sites.

The surface morphology of the prepared CFZO and AZO thin films has been observed by FESEM. Figure 3 shows that the surface of deposited films has homogeneous, continuous and dense structures. The average grain size of

Fig. 2 EDX spectroscopy of **a** $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ single layer annealed at 800 °C in flowing argon gas atmosphere for 1 h and **b** $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ single layer annealed in a vacuum furnace (with a pressure of 10^{-5} mbar) at 500 °C for 1 h



$\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ and $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ thin films is typically around 62 and 39 nm, respectively. Figure 4 shows the AFM images of the films. The root mean square (RMS) roughness of the CFZO single layer is about 62.4 nm. In contrast, the surface of $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ is smooth, regular and uniform. The roughness of this thin film is around 10.1 nm. The smooth surface of AZO/quartz makes it a good substrate for preparation of CFZO/AZO/quartz heterojunction.

Figure 5a shows the transmission spectra of the thin films deposited onto the quartz substrate. As can be seen, the transmittance of CFZO thin film is around 25–50 % in the visible range. This result is similar to that of CuFeO_2

prepared by Chen et al. [11]. Transmittance of CuFeO_2 is lower than those of CuAlO_2 [16] and CuCrO_2 [30] delafossites which is due to d–d transition of iron [11]. The transmittance of AZO thin film is also seen in Fig. 5 which is higher than 90 % in the visible region. For this reason, AZO thin film is appropriate as a window layer in diode fabrication. We can determine the optical band gap of the layers by using the transmission spectra. The electron excitation from the valance to the conduction band requires energy around the band gap energy. The absorption coefficient relates to the photon energy $h\nu$ through $(\alpha h\nu)^2 = A(h\nu - E_g)$, where A is a constant and E_g is the optical band gap energy [33]. As seen in Fig. 5b, the plot of $(\alpha h\nu)^2$

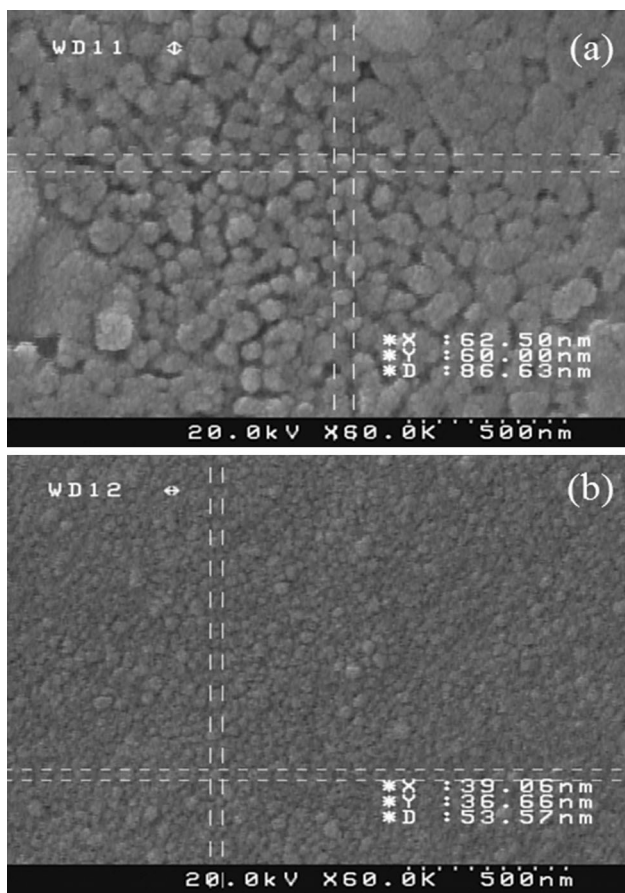


Fig. 3 SEM images of **a** $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ single layer on quartz substrate annealed at $800\text{ }^\circ\text{C}$ in flowing argon gas atmosphere for 1 h, and **b** $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ single layer annealed in a vacuum furnace at $500\text{ }^\circ\text{C}$ for 1 h

against $h\nu$ near the fundamental absorption edge determines the direct energy band gap [34] of CFZO which is about 3.11 eV. The direct band gap of AZO is also determined as 3.3 eV. These materials with band gaps higher than 3.0 eV are suitable for fabrication of transparent diodes.

The n-type conductivity of AZO single layer and p-type conductivity of CFZO single layer have been confirmed by using the hot-probe technique. We have also used the Hall effect setup to measure the carrier concentration and charge carrier mobility of the prepared thin films. The carrier concentration and mobility of the AZO thin film are $2.8 \times 10^{19}\text{ cm}^{-3}$ and $3.27\text{ cm}^2/\text{Vs}$, respectively. These values for the CFZO thin film are $1.2 \times 10^{19}\text{ cm}^{-3}$ and $2.6\text{ cm}^2/\text{Vs}$, respectively. To calculate the conductivity of the thin films, we have used $\sigma = en\mu$ equation in which σ , e , n and μ are conductivity, electron charge magnitude, carrier concentration and mobility of carriers, respectively. The conductivity has been obtained as $14.69\text{ S}\cdot\text{cm}^{-1}$ for the AZO thin layer and $4.9\text{ S}\cdot\text{cm}^{-1}$ for the CFZO single layer. The electrical conductivity in Al-doped ZnO films is known to be essentially due to the substitution of the Al^{3+} ions for the Zn^{2+} sites, Zn and Al interstitial atoms and oxygen vacancies [35]. The conductivity of the produced CFZO thin film is higher than that of CuFeO_2 thin films fabricated by Chen et al. [11]. The improvement in electrical properties of CuFeO_2 by doping of divalent cations has also already been reported. When Zn^{2+} is substituted for Fe^{3+} , because of creating the hole, the p-type electrical conductivity is improved [36].

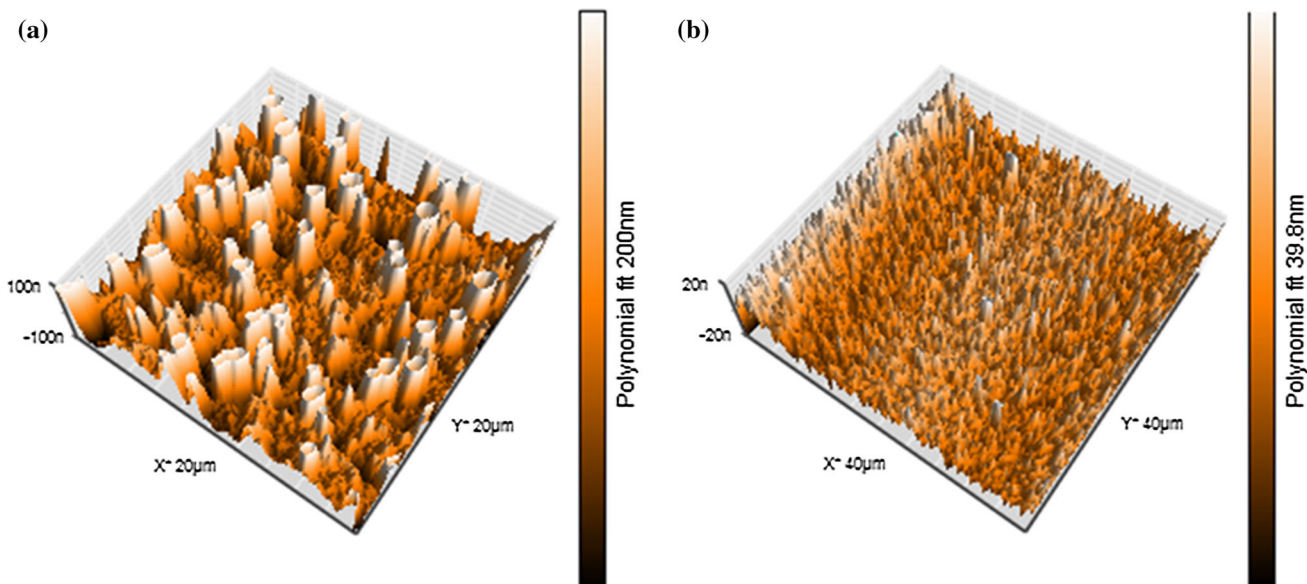


Fig. 4 AFM images of **a** $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ single layer annealed at $800\text{ }^\circ\text{C}$ in flowing argon gas atmosphere for 1 h, and **b** $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ single layer on quartz substrate annealed in a vacuum furnace at $500\text{ }^\circ\text{C}$ for 1 h

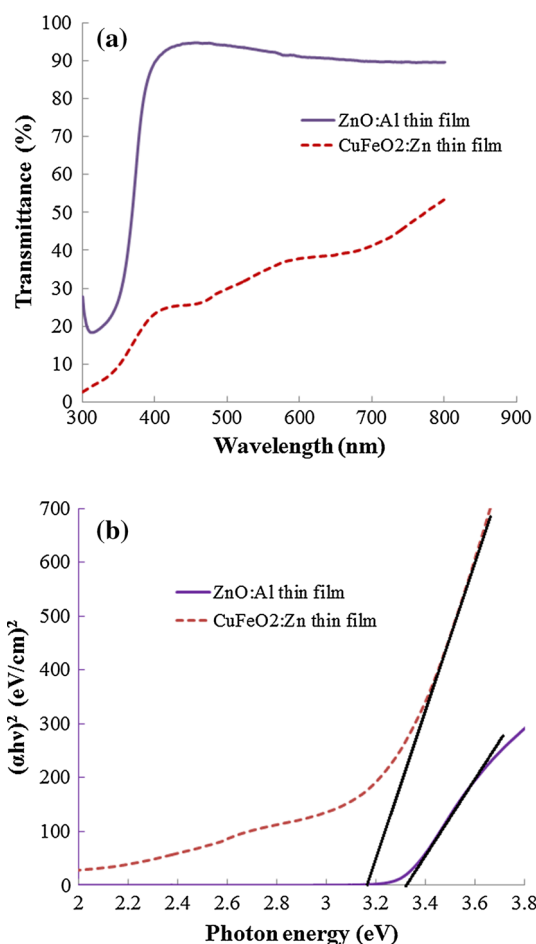


Fig. 5 **a** Transmittance spectra and **b** plots of $(\alpha h\nu)^2$ versus photon energy of the $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ single layer annealed at 800 °C in flowing argon gas atmosphere for 1 h and the $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ single layer annealed in a vacuum furnace at 500 °C for 1 h

Having achieved transparent CFZO and AZO single layers, we fabricate the all-oxide p-n heterojunction diode on quartz substrate (19 mm × 19 mm) by using the all-chemical solution deposition approach. For preparation of heterojunction, firstly AZO thin film is fabricated on quartz substrate and annealed in a vacuum furnace to increase its conductivity. According to Fig. 3, this treatment makes the surface of the AZO film so smooth for subsequent deposition of the p-layer. The smooth surface of the AZO can prevent the interdiffusion of the AZO and CFZO layers. After preparing the AZO layer, the CFZO thin film is deposited on the surface of the annealed AZO/quartz substrate. Finally, the prepared CFZO/AZO/quartz heterojunction is annealed at 800 °C in flowing argon gas (purity 99.99 %) atmosphere for 1 h to obtain the delafossite structure of CFZO layer. Figure 6a shows the XRD pattern of the fabricated p-n heterojunction. As can be seen from this figure, the reflection peaks of CFZO have been obtained besides the peaks of the AZO. The XRD pattern of the heterojunction shows that the intensity of CFZO peaks has increased in comparison with

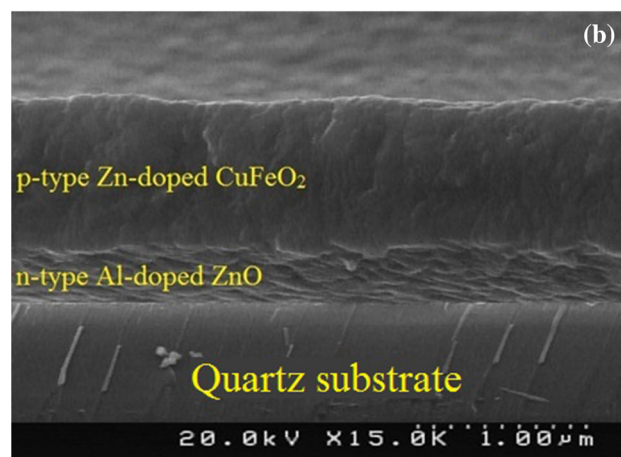
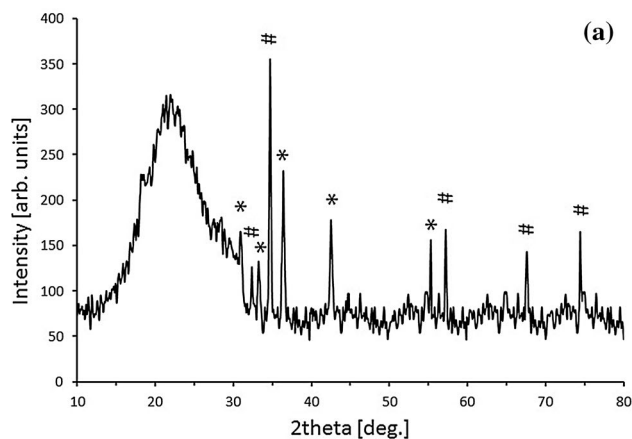


Fig. 6 **a** XRD pattern and **b** cross-sectional FESEM image of the fabricated p-n junction. The AZO layer in this heterojunction has been exposed to two-step annealing. Firstly, at 500 °C for 1 h in vacuum and then (in the presence of the overlayer), for 1 h at 800 °C in flowing argon gas

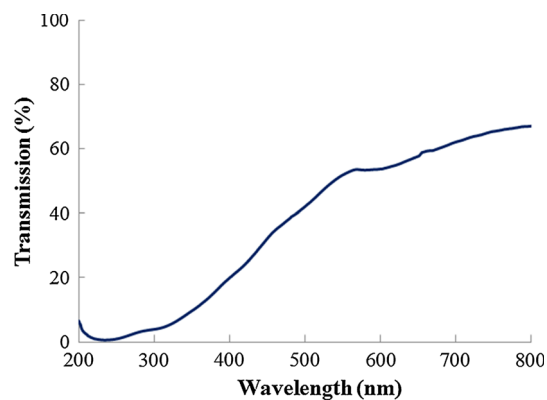


Fig. 7 Transmittance of p- $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ /n- $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ /quartz heterojunction

that of the CFZO single layer (see Fig. 1a). The exhibited cross-sectional FESEM image of CFZO/AZO heterojunction on quartz substrate in Fig. 6b reveals that the interface of CFZO/AZO is smooth. From the cross-sectional FESEM

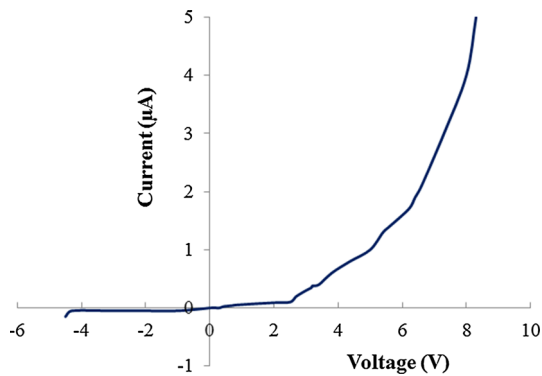


Fig. 8 I–V curve of n- $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}/\text{p-CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ heterojunction

image of the CFZO/AZO heterojunction, the thicknesses of AZO and CFZO layers are estimated as around 320 and 920 nm, respectively.

Figure 7 shows the optical spectrum of $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2/\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ heterojunction. The transmission of heterojunction diode with thickness of 1240 nm is around 55 % at 550 nm which is higher than that of a CFZO single layer. The increase of transmittance in comparison with the CFZO single layer can be ascribed to the interference of light at CFZO/AZO and AZO/quartz interfaces. Similar interference effect was observed for $\text{n}^+\text{-ZnO}/\text{n-ZnO}/\text{p-CuCrO}_2\text{:Mg}/\text{ITO}$ p-n junction prepared by pulsed laser deposition by Tonooka et al. [19]. The current–voltage characteristic of the p-n heterojunction has been measured by four-probe setup. As seen in Fig. 8, the nonlinear I–V curve confirms the rectifying property of the created diode. By forward bias measurement, we find the maximum current at 8 V as 5 μA . Moreover, the leakage current is obtained around 50 nA by reverse bias. The reverse breakdown voltage for bilayer structure is around 4 V. The rectifying character accompanied by the optical transparency of the constructed diode verifies the potential of the sol–gel method in producing transparent diodes.

4 Conclusions

In summary, we assembled the p-n heterojunction based on $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2$ and $\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ thin films on quartz substrate by using sol–gel and spin-coating techniques. It was observed from the experimental results that the AZO thin film is highly transparent having a very smooth surface in comparison with the CFZO thin film. Due to this reason, the AZO coated on quartz was employed as the substrate for deposition of CFZO thin film. Then, the electro-optical properties of the constructed $\text{CuFe}_{0.95}\text{Zn}_{0.05}\text{O}_2/\text{Zn}_{0.99}\text{Al}_{0.01}\text{O}$ heterojunction confirmed that the fabricated p-n heterojunction has

rectifying behavior and a transmittance of light around 55 % at the wavelength of 550 nm.

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